

MC74AC573, MC74ACT573

Octal Buffer/Line Driver with 3-State Outputs

The MC74AC573/74ACT573 is a high-speed octal latch with buffered common Latch Enable (LE) and buffered common Output Enable (\overline{OE}) inputs.

The MC74AC573/74ACT573 is functionally identical to the MC74AC373/74ACT373 but has inputs and outputs on opposite sides.

Features

- Inputs and Outputs on Opposite Sides of Package Allowing Easy Interface with Microprocessors
- Useful as Input or Output Port for Microprocessors
- Functionally Identical to MC74AC373/74ACT373
- 3-State Outputs for Bus Interfacing
- Outputs Source/Sink 24 mA
- 'ACT573 Has TTL Compatible Inputs
- These are Pb-Free Devices

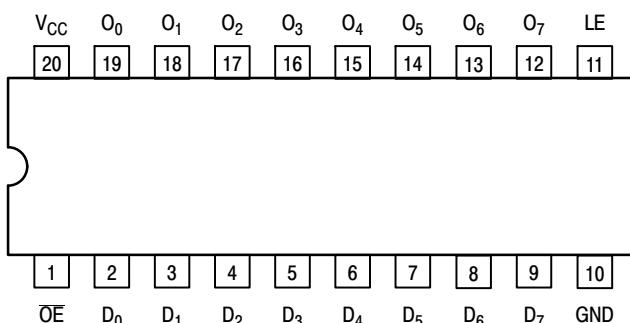


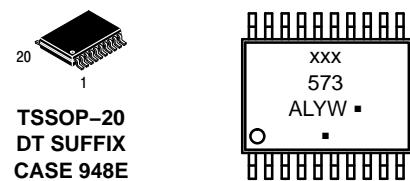
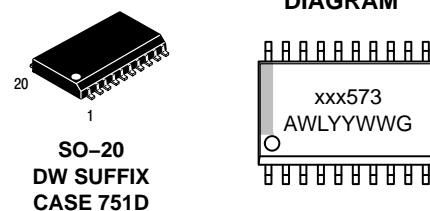
Figure 1. Pinout 20-Lead Packages Conductors
(Top View)



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MARKING DIAGRAM



xxx = AC or ACT
A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G or ▀ = Pb-Free Package
(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

PIN ASSIGNMENT

PIN	FUNCTION
D ₀ -D ₇	Data Inputs
LE	Latch Enable Input
OE	3-State Output Enable Input
O ₀ -O ₇	3-State Latch Outputs

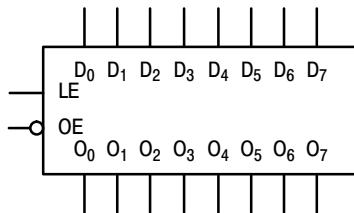


Figure 2. Logic Symbol

MC74AC573, MC74ACT573

TRUTH TABLE

Inputs		Outputs	
OE	LE	D _n	O _n
L	H	H	H
L	H	L	L
L	L	X	O ₀
H	X	X	Z

H = HIGH Voltage Level

L = LOW Voltage Level

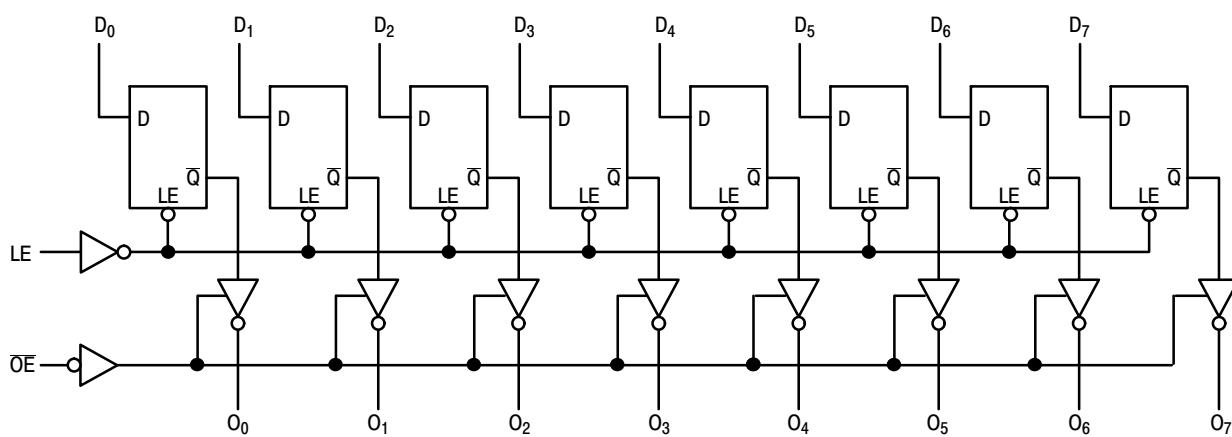
Z = High Impedance

X = Immaterial

O₀ = Previous O₀ before LOW-to-HIGH Transition of Clock

Functional Description

The MC74AC573/74ACT574 contains eight D-type latches with 3-state output buffers. When the Latch Enable (LE) input is HIGH, data on the D_n inputs enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time its D input changes. When LE is LOW the latches store the information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LE. The 3-state buffers are controlled by the Output Enable (\overline{OE}) input. When \overline{OE} is LOW, the buffers are enabled. When \overline{OE} is HIGH the buffers are in the high impedance mode but this does not interfere with entering new data into the latches.



NOTE: That this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 3. Logic Diagram

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MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V_{CC}	DC Supply Voltage (Referenced to GND)		−0.5 to +7.0	V
V_{IN}	DC Input Voltage (Referenced to GND)		−0.5 to V_{CC} +0.5	V
V_{OUT}	DC Output Voltage (Referenced to GND) (Note 1)		−0.5 to V_{CC} +0.5	V
I_{IK}	DC Input Diode Current		±20	mA
I_{OK}	DC Output Diode Current		±50	mA
I_{OUT}	DC Output Sink/Source Current		±50	mA
I_{CC}	DC Supply Current, per Output Pin		±50	mA
I_{GND}	DC Ground Current, per Output Pin		±100	mA
T_{STG}	Storage Temperature Range		−65 to +150	°C
T_L	Lead temperature, 1 mm from Case for 10 Seconds		260	°C
T_J	Junction Temperature Under Bias		140	°C
θ_{JA}	Thermal Resistance (Note 2)	SOIC TSSOP	65.8 110.7	°C/W
MSL	Moisture Sensitivity		Level 1	
F_R	Flammability Rating	Oxygen Index: 30% – 35%	UL 94 V-0 @ 0.125 in	
V_{ESD}	ESD Withstand Voltage	Human Body Model (Note 3) Machine Model (Note 4) Charged Device Model (Note 5)	> 2000 > 200 > 1000	V
$I_{Latchup}$	Latchup Performance	Above V_{CC} and Below GND at 85°C (Note 6)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. I_{OUT} absolute maximum rating must be observed.
2. The package thermal impedance is calculated in accordance with JESD 51–7.
3. Tested to EIA/JESD22-A114-A.
4. Tested to EIA/JESD22-A115-A.
5. Tested to JESD22-C101-A.
6. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Typ	Max	Unit
V_{CC}	Supply Voltage	'AC	2.0	5.0	6.0	V
		'ACT	4.5	5.0	5.5	
V_{IN}, V_{OUT}	DC Input Voltage, Output Voltage (Ref. to GND)		0	–	V_{CC}	V
t_r, t_f	Input Rise and Fall Time (Note 1) 'AC Devices except Schmitt Inputs	V_{CC} @ 3.0 V	–	150	–	ns/V
		V_{CC} @ 4.5 V	–	40	–	
		V_{CC} @ 5.5 V	–	25	–	
t_r, t_f	Input Rise and Fall Time (Note 2) 'ACT Devices except Schmitt Inputs	V_{CC} @ 4.5 V	–	10	–	ns/V
		V_{CC} @ 5.5 V	–	8.0	–	
T_A	Operating Ambient Temperature Range		−40	25	85	°C
I_{OH}	Output Current – High		–	–	−24	mA
I_{OL}	Output Current – Low		–	–	24	mA

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. V_{IN} from 30% to 70% V_{CC} ; see individual Data Sheets for devices that differ from the typical input rise and fall times.
2. V_{IN} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

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DC CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	74AC		74AC	Unit	Conditions
			$T_A = +25^\circ C$		$T_A = -40^\circ C$ to $+85^\circ C$		
			Typ	Guaranteed Limits			
V_{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V_{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V_{OH}	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	V	$I_{OUT} = -50 \mu A$
		3.0 4.5 5.5	— — —	2.56 3.86 4.86	2.46 3.76 4.76	V	* $V_{IN} = V_{IL}$ or V_{IH} —12 mA I_{OH} —24 mA —24 mA
		3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	V	$I_{OUT} = 50 \mu A$
		3.0 4.5 5.5	— — —	0.36 0.36 0.36	0.44 0.44 0.44	V	* $V_{IN} = V_{IL}$ or V_{IH} 12 mA I_{OL} 24 mA 24 mA
I_{IN}	Maximum Input Leakage Current	5.5	—	± 0.1	± 1.0	μA	$V_I = V_{CC}, GND$
I_{OZ}	Maximum 3-State Current	5.5	—	± 0.5	± 5.0	μA	$V_I (OE) = V_{IL}, V_{IH}$ $V_I = V_{CC}, GND$ $V_O = V_{CC}, GND$
I_{OLD}	†Minimum Dynamic Output Current	5.5	—	—	75	mA	$V_{OLD} = 1.65 V$ Max
I_{OHD}		5.5	—	—	-75	mA	$V_{OHD} = 3.85 V$ Min
I_{CC}	Maximum Quiescent Supply Current	5.5	—	8.0	80	μA	$V_{IN} = V_{CC}$ or GND

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC} .

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

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AC CHARACTERISTICS (For Figures and Waveforms – See Section 3)

Symbol	Parameter	V _{CC} * (V)	74AC			74AC		Unit	Fig. No.		
			T _A = +25°C C _L = 50 pF			T _A = -40°C to +85°C C _L = 50 pF					
			Min	Typ	Max	Min	Max				
t _{PLH}	Propagation Delay D _n to O _n	3.3 5.0	2.5 2.5	– –	13.0 10.0	2.0 2.0	15.0 11.5	ns	3-5		
t _{PHL}	Propagation Delay D _n to O _n	3.3 5.0	2.5 2.5	– –	12.0 9.5	2.0 2.0	14.0 11.0	ns	3-5		
t _{PLH}	Propagation Delay LE to O _n	3.3 5.0	2.5 2.5	– –	13.0 9.5	2.0 2.0	15.0 11.0	ns	3-6		
t _{PHL}	Propagation Delay LE to O _n	3.3 5.0	2.5 2.5	– –	12.0 8.5	2.0 2.0	14.0 10.0	ns	3-6		
t _{PZH}	Output Enable Time	3.3 5.0	2.5 2.5	– –	11.0 9.0	2.0 2.0	12.0 10.0	ns	3-7		
t _{PZL}	Output Enable Time	3.3 5.0	2.5 2.5	– –	11.0 8.5	2.0 2.0	12.5 9.5	ns	3-8		
t _{PHZ}	Output Disable Time	3.3 5.0	2.5 2.5	– –	12.5 11.0	2.0 2.0	13.5 12.0	ns	3-7		
t _{PLZ}	Output Disable Time	3.3 5.0	2.5 2.5	– –	9.5 8.0	2.0 2.0	10.5 9.0	ns	3-8		

*Voltage Range 3.3 V is 3.3 V \pm 0.3 V.

Voltage Range 5.0 V is 5.0 V \pm 0.5 V.

AC OPERATING REQUIREMENTS

Symbol	Parameter	V _{CC} * (V)	74AC		74AC	Unit	Fig. No.
			T _A = +25°C C _L = 50 pF		T _A = -40°C to +85°C C _L = 50 pF		
			Typ	Guaranteed Minimum			
t _s	Setup Time, HIGH or LOW D _n to LE	3.3 5.0	– –	3.5 3.0	4.0 3.5	ns	3-9
t _h	Hold Time, HIGH or LOW D _n to LE	3.3 5.0	– –	2.0 2.0	2.0 2.0	ns	3-9
t _w	LE Pulse Width, HIGH	3.3 5.0	– –	6.0 4.0	7.0 5.0	ns	3-6

*Voltage Range 3.3 V is 3.3 V \pm 0.3 V.

Voltage Range 5.0 V is 5.0 V \pm 0.5 V.

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DC CHARACTERISTICS

Symbol	Parameter	V_{CC} (V)	74ACT		74ACT		Unit	Conditions		
			$T_A = +25^\circ C$		$T_A = -40^\circ C \text{ to } +85^\circ C$					
			Typ	Guaranteed Limits						
V_{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0		V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$		
V_{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8		V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$		
V_{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4		V	$I_{OUT} = -50 \mu A$		
		4.5 5.5	— —	3.86 4.86	3.76 4.76		V	* $V_{IN} = V_{IL} \text{ or } V_{IH}$ $-24 mA$ I_{OH} $-24 mA$		
V_{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1		V	$I_{OUT} = 50 \mu A$		
		4.5 5.5	— —	0.36 0.36	0.44 0.44		V	* $V_{IN} = V_{IL} \text{ or } V_{IH}$ $24 mA$ I_{OL} $24 mA$		
I_{IN}	Maximum Input Leakage Current	5.5	—	± 0.1	± 1.0		μA	$V_I = V_{CC}, GND$		
ΔI_{CCT}	Additional Max. I_{CC} /Input	5.5	0.6	—	1.5		mA	$V_I = V_{CC} - 2.1 V$		
I_{OZ}	Maximum 3-State Current	5.5	—	± 0.5	± 5.0		μA	$V_I (OE) = V_{IL}, V_{IH}$ $V_I = V_{CC}, GND$ $V_O = V_{CC}, GND$		
I_{OLD}	†Minimum Dynamic Output Current	5.5	—	—	75		mA	$V_{OLD} = 1.65 V$ Max		
I_{OHD}		5.5	—	—	-75		mA	$V_{OHD} = 3.85 V$ Min		
I_{CC}	Maximum Quiescent Supply Current	5.5	—	8.0	80		μA	$V_{IN} = V_{CC}$ or GND		

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS (For Figures and Waveforms – See Section 3)

Symbol	Parameter	V_{CC}^* (V)	74ACT			74ACT		Unit	Fig. No.		
			$T_A = +25^\circ C$ $C_L = 50 pF$			$T_A = -40^\circ C$ $\text{to } +85^\circ C$ $C_L = 50 pF$					
			Min	Typ	Max	Min	Max				
t_{PLH}	Propagation Delay D_n to O_n	5.0	2.5	—	10.5	2.0	12	ns	3-5		
t_{PHL}	Propagation Delay D_n to O_n	5.0	2.5	—	10.5	2.0	12	ns	3-5		
t_{PLH}	Propagation Delay LE to O_n	5.0	3.0	—	10.5	2.5	12	ns	3-6		
t_{PHL}	Propagation Delay LE to O_n	5.0	2.5	—	9.5	2.0	10.5	ns	3-6		
t_{PZH}	Output Enable Time	5.0	2.0	—	10	1.5	11	ns	3-7		
t_{PZL}	Output Enable Time	5.0	1.5	—	9.5	1.5	10.5	ns	3-8		
t_{PHZ}	Output Disable Time	5.0	2.5	—	11	1.5	12.5	ns	3-7		
t_{PLZ}	Output Disable Time	5.0	1.5	—	8.5	1.0	9.5	ns	3-8		

*Voltage Range 5.0 V is $5.0 V \pm 0.5 V$.

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AC OPERATING REQUIREMENTS

Symbol	Parameter	V _{CC} * (V)	74ACT		74ACT	Unit	Fig. No.
			T _A = +25°C C _L = 50 pF		T _A = -40°C to +85°C C _L = 50 pF		
			Typ	Guaranteed Minimum			
t _s	Setup Time, HIGH or LOW D _n to LE	5.0	–	3.0	3.5	ns	3–9
t _h	Hold Time, HIGH or LOW D _n to LE	5.0	–	0	0	ns	3–9
t _w	LE Pulse Width, HIGH	5.0	–	3.5	4.0	ns	3–6

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

CAPACITANCE

Symbol	Parameter	Value Typ	Unit	Test Conditions
C _{IN}	Input Capacitance	5.0	pF	V _{CC} = 5.0 V
C _{PD}	Power Dissipation Capacitance	25	pF	V _{CC} = 5.0 V

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ORDERING INFORMATION

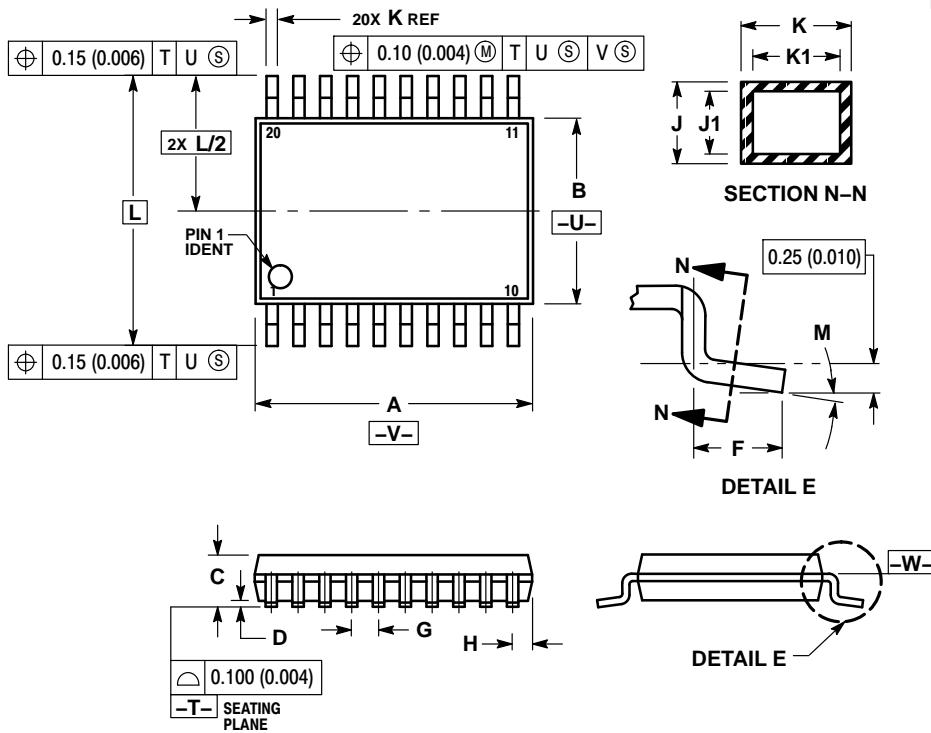
Device	Package	Shipping [†]
MC74AC573DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74AC573DWR2G	SOIC-20 (Pb-Free)	1000 Units / Tape & Reel
MC74AC573DTR2G	TSSOP-20 (Pb-Free)	2500 Units / Tape & Reel
MC74ACT573DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74ACT573DWR2G	SOIC-20 (Pb-Free)	1000 Units / Tape & Reel
MC74ACT573DTR2G	TSSOP-20 (Pb-Free)	2500 Units / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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PACKAGE DIMENSIONS

**TSSOP-20
DT SUFFIX
CASE 948E-02
ISSUE C**

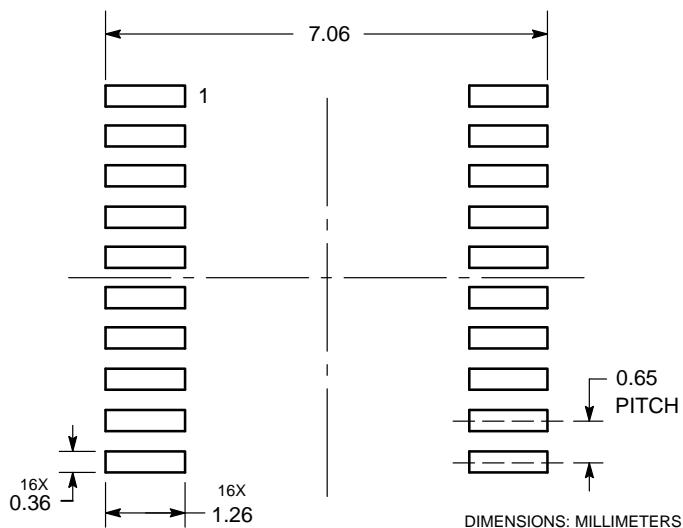


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -U-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	6.40	6.60	0.252	0.260
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

SOLDERING FOOTPRINT*

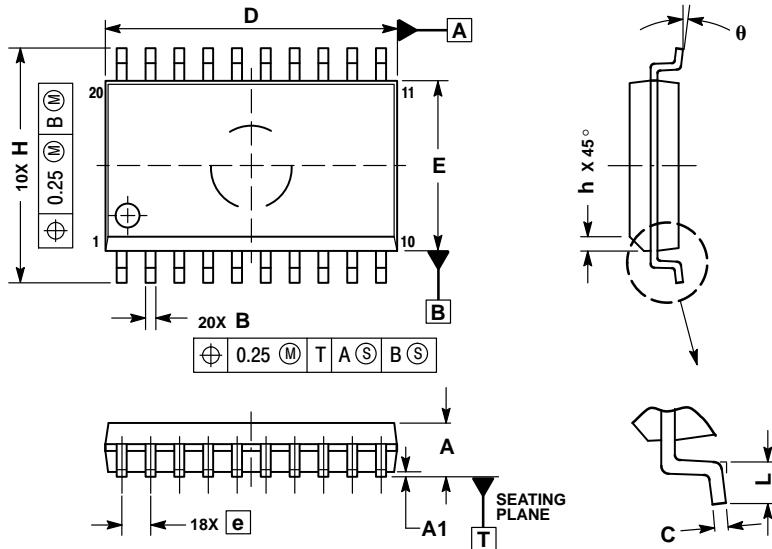


*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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PACKAGE DIMENSIONS

**SOIC-20W
DW SUFFIX
CASE 751D-05
ISSUE G**



NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS	
	MIN	MAX
A	2.35	2.65
A1	0.10	0.25
B	0.35	0.49
C	0.23	0.32
D	12.65	12.95
E	7.40	7.60
e	1.27 BSC	
H	10.05	10.55
h	0.25	0.75
L	0.50	0.90
θ	0 °	7 °

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